



# Product Change Notification

## 109987 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

Asia Pacific Contact: [apacgccb@intel.com](mailto:apacgccb@intel.com)

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# Product Change Notification

**Change Notification #:** 109987 - 00  
**Change Title:** Intel NAND Flash Memory, PCN 109987-00, Label, Label Change  
**Date of Publication:** April 26, 2010

## Key Characteristics of the Change:

Label





## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	May 28, 2010
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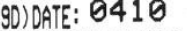
## Description of Change to the Customer:

Intel is adding one additional field to its intermediate box and desiccant bag label. This data is for use by Intel, and has no customer data. No changes to customer data fields will occur.

Old Label:

(P) CUST PROD:	(1B) BOX: DD000887
(V) SUPPLIER: 04195 INTEL	
(1P) IPN: JS29F08G08FANA2	MAX REFLOW 260 °C
(S) SPEC:	TEMP 
(30P) MM#: 879331	LEVEL 3 168 hours
(1T) LOT: BXK7KW81	BAG SEAL DATE 01Apr10
(Q) QTY: 1000	
(9D) DATE: 0410	
Ph-FRFF 03	ASSEMBLED IN Taiwan

New Label:

(P) CUST PROD:	(1B) BOX: DD000887	LOC:
(V) SUPPLIER: 04195 INTEL		
(1P) IPN: JS29F08G08FANA2	MAX REFLOW 260 °C	
(S) SPEC:	TEMP 	
(30P) MM#: 879331	LEVEL 3 168 hours	
(1T) LOT: BXK7KW81	BAG SEAL DATE 01Apr10	
(Q) QTY: 1000		
(9D) DATE: 0410		
Ph-FRFF 03	ASSEMBLED IN Taiwan	

## **Customer Impact of Change and Recommended Action:**

Please review the proposed label changes detailed in the PCN.

## **Products Affected:**

All Intel® NAND Flash Memory

## **PCN Revision History:**

**Date of Revision:**

April 26, 2010

**Revision Number:**

00

**Reason:**

Originally Published PCN